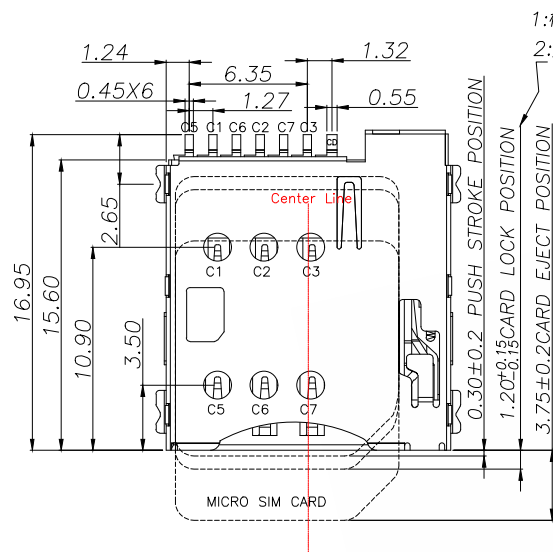
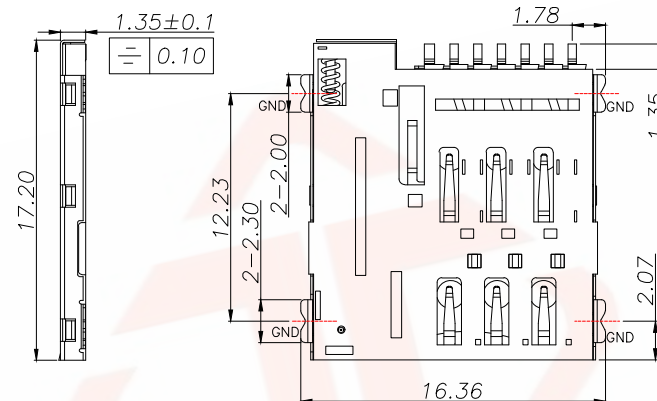


REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



1:标准卡外漏:1.30,标准卡长度15.00mm
 2:剪卡外漏:1.0,剪卡长度14.80mm



MATERIAL:

INSULATOR: HIGH TERMERATURE THERMOPLASTIC,UL 94V-0

CONTACT: COPPER ALLOY

SHELL: SUS

PLATING:

CONTACT: PLATED 50U" NI OVER ALL CONTACT AU 1U

SHELL: PLATED 50U" NI OVERALL

PLATED 1U" AU SELECTIVE CONTACT AREA

ELECTRICAL:

CURRENT RATING: 0.5AMPS MAX

VOLTAGE RATING: 5V AC/DC

AMBIENT TEMPERATURE RANGE: -40℃ ~ +85℃

STORAGE TEMPERATURE RANGE: -40℃ ~ +85℃

AMBIENT HUMIDITY RANGE: 95% R.H. MAX.

CONTACT RESISTANCE: 100M MAX.Ω

INSULATION RESISTANCE: 1000M MIN./500VDCΩ

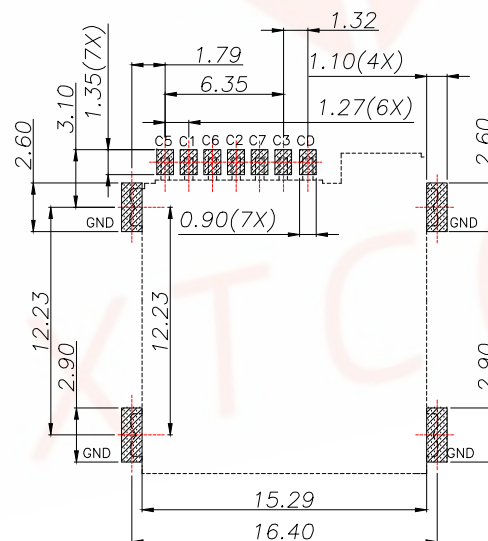
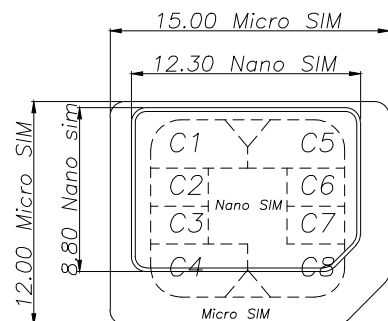
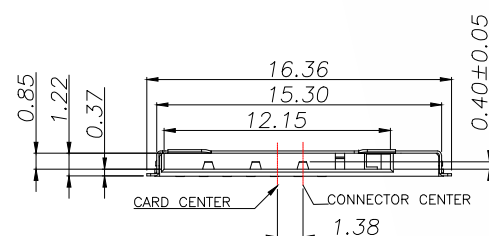
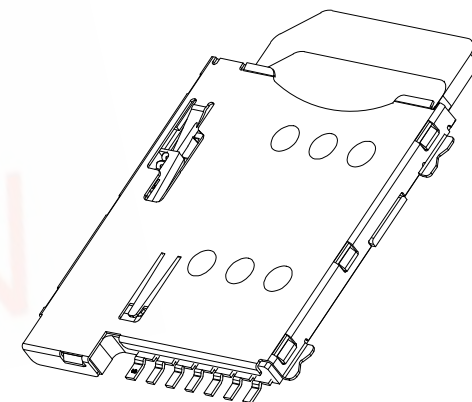
REFLOW PEAK TEMP: 260℃

MATING CYCLES: 5000MIN INSERTIONS

Circuit Diagram for Detect Switch

WITHOUT CARD	CLOSE	CLOSE CD GND(SHELL)
INSERTING CARD	OPEN	OPEN CD GND(SHELL)

MICRO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A
CD	DETECTION SWITCH



PAD AREA

KEEP OUT AREA

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ±0.05

TOLERANCE

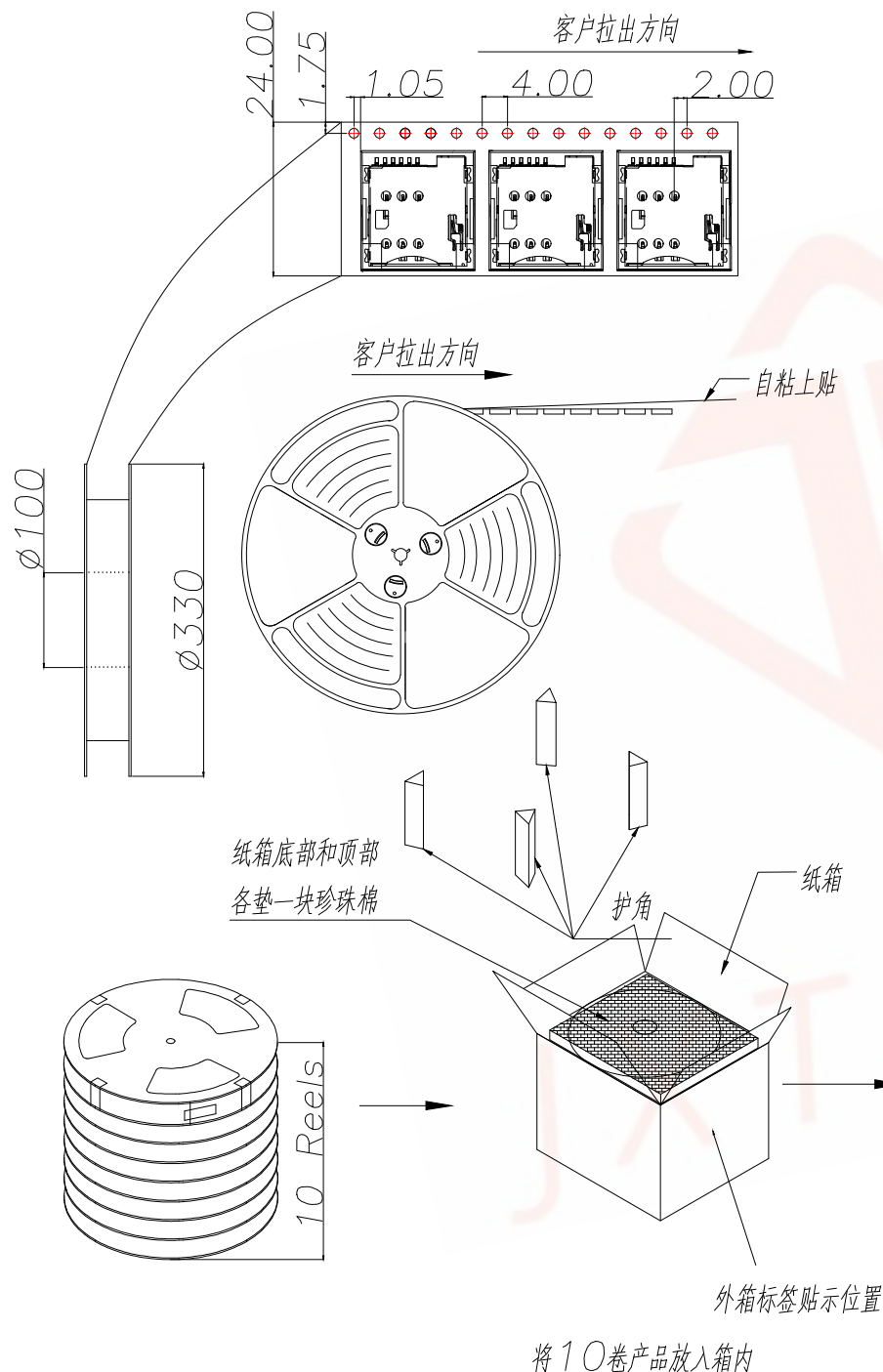
X.X:±0.35	X.X':±3"
X.XX:±0.25	X.XX':±2"
X.XXX:±0.15	
UNITS	mm
MATERILA	---
FINISH	---



深圳聚兴泰电子科技有限公司
 Shenzhen Juxingtai Electronic Technology Co., Ltd

PART NO.	TITLE: MICRO SIM CARD
ASIM-H135-7P	PUSH PUSH 6+1PIN H1.35
DESIGN: Ethan	MANUFACTURE DWG
CHED: Olvia	SCALE
APPD: Ava	SHEET
	N:A
	1/1

REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



NOTES

1. 每卷包装数量: 1000PCS/每卷
2. 卷带包装方式:

空15PCS	产品1000PCS	空5PCS
轴心段空300mm	产品放置区	尾部100mm

3. 每箱包装数量: 10000PCS/箱
4. 纸箱350mm*350mm*440mm(内部尺寸), 材质K=K

TOLERANCE		 深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd		
X.X:±0.35	X.X':±3"	PART NO. ASIM-H135-7P	TITLE: MICRO SIM CARD PUSH PUSH 6+1PIN H1.35	
X.XX:±0.25	X.XX':±2"			
X.XXX:±0.15				
UNITS	mm	DESIGN: Ethan	MANUFACTURE DWG	
MATERILA	---	CHED: Olvia		
FINISH	---	APPD: Ava	 SCALE N:A	SHEET 1/1